

Telink Semiconductor to Exhibit at LIGHTFAIR® International 2019 in Philadelphia, Pennsylvania, May 21-23

SANTA CLARA, CALIFORNIA, MAY 6, 2019 -- Telink Semiconductor is proud to announce that we will be exhibiting at [LIGHTFAIR® International 2019](#) in Philadelphia, Pennsylvania, from Tuesday, May 21, through Thursday, May 23.

This is a landmark year for LIGHTFAIR® International, which over the last three decades has become the world's largest annual architectural and commercial lighting trade show. To celebrate its 30th staging, LIGHTFAIR® will welcome over 550 exhibitors and 25,000 attendees hailing from more than 80 countries and all 50 U.S. states.

LIGHTFAIR® International has always made a concerted effort to keep its finger on the pulse of the lighting and design industry, and this year will feature presentations in key emerging verticals like solar power, intelligent buildings, and the Internet of Things (IoT).

“For three decades, the LIGHTFAIR® trade show has presented the best of what is new and next to the global lighting and design community,” [says](#) LIGHTFAIR® International Senior Vice President Dan Darby. “Our 2019 staging sustains that mission with a product mix of incredible depth and diversity spanning the lighting and technology spectrum. Innovations, introductions, ideations, and discoveries will abound in Philadelphia.”

These innovations, introductions, ideations, and discoveries will be spread across six curated Pavilions on the trade show floor. Attendees will be able to find Telink at [Booth #4240 in the IoT Pavilion](#).

Jim Wargnier, VP, explains, “Telink is a leader in connected lighting. We pioneer advanced network technology and partner with eminent companies in the industry to create systems that are more environmentally friendly and do more for consumers. LIGHTFAIR® International is the foremost conference in this space, so we are exceedingly proud to be participating this year. We are excited to meet, learn from, and collaborate with the innovators who are pushing the envelope in lighting.”

If you would like to set up a specific time to meet with a Telink representative during LIGHTFAIR® International 2019, [please contact Telink VP Jim Wargnier](#). Whether you choose to schedule a meeting or just drop by our booth, we would love to talk all things lighting and tech.

We look forward to seeing you in Philadelphia.

ABOUT TELINK: Founded in 2010, [Telink Semiconductor](#) is a fabless integrated circuit design company with offices in California, Shanghai, Shenzhen, Taiwan, and Hong Kong. Telink is

dedicated to the development of highly integrated low-power radio-frequency and mixed signal system chips for Internet of Things applications. Telink's product portfolio is aimed at serving markets ranging from smart lighting to home automation to smart cities, and currently includes 2.4Ghz RF SoCs for Bluetooth Smart, Zigbee, 6LoWPAN/Thread, and Homekit.

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About Telink

TELINK SEMICONDUCTOR (Shanghai) CO, LTD is a fabless IC design company and was founded in 2010 with subsidiaries and offices in California, Shenzhen, Taiwan and Hong Kong. Telink is dedicated to the development of highly integrated and low power radio-frequency and mixed signal system chips for Internet of Things (IoT) applications. The current product portfolio from Telink includes 2.4Ghz RF SoCs for Bluetooth Smart, Zigbee, 6LoWPAN/Thread, and Homekit and low-power high-precision analog ICs for resistive/capacitive/electromagnetic touch control, serving numerous markets including smart lighting, home automation, smart city, and other consumer electronics markets.

<https://finance.yahoo.com/news/idt-telink-semiconductor-announce-partnership-113300028.html>